

Symbol	Parameter		Ratings	Units	
V <sub>DSS</sub>	Drain-to-Source Voltage		80	V	
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V	
	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> =25°C	300	Α	
	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4		
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	820	mJ	
P <sub>D</sub>	Power Dissipation		429	W	
	Derate Above 25°C		2.86	W/ <sup>o</sup> C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.35	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient (Note 3)		43	°C/W	

Notes:

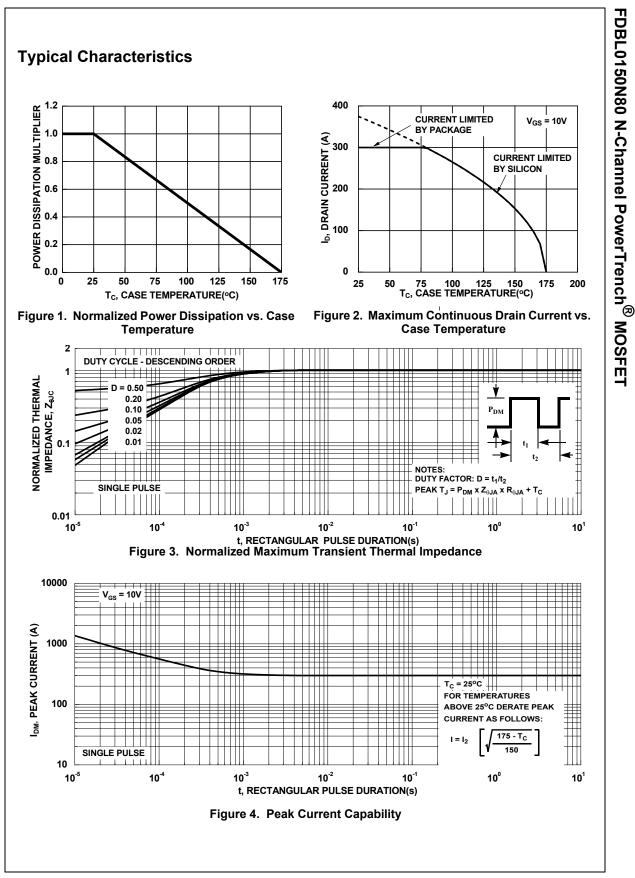
1: Current is limited by bondwire configuration.

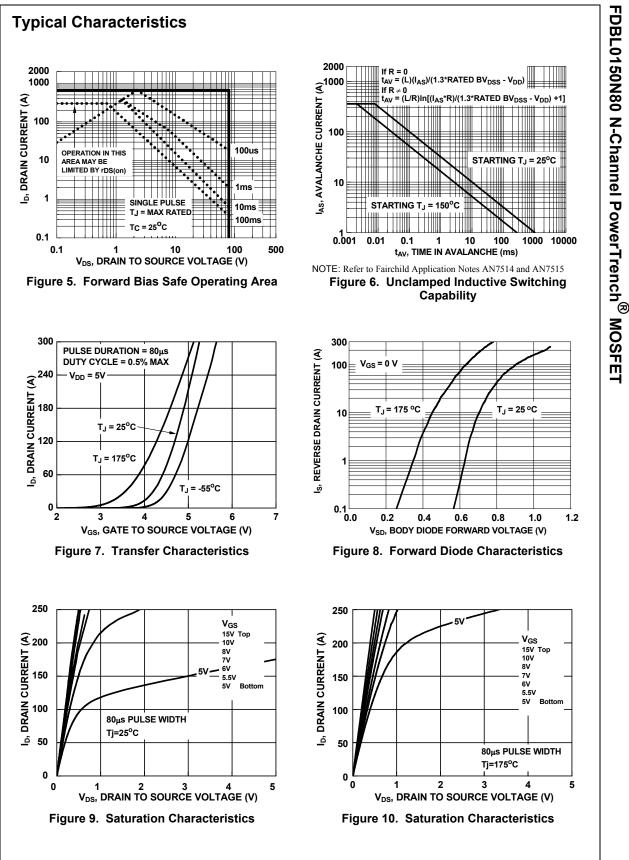
2: Starting T<sub>J</sub> = 25°C, L = 0.4mH,  $I_{AS}$  = 64A,  $V_{DD}$  = 40V during inductor charging and  $V_{DD}$  = 0V during time in avalanche. 3:  $R_{0,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder moduling surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

## Package Marking and Ordering Information

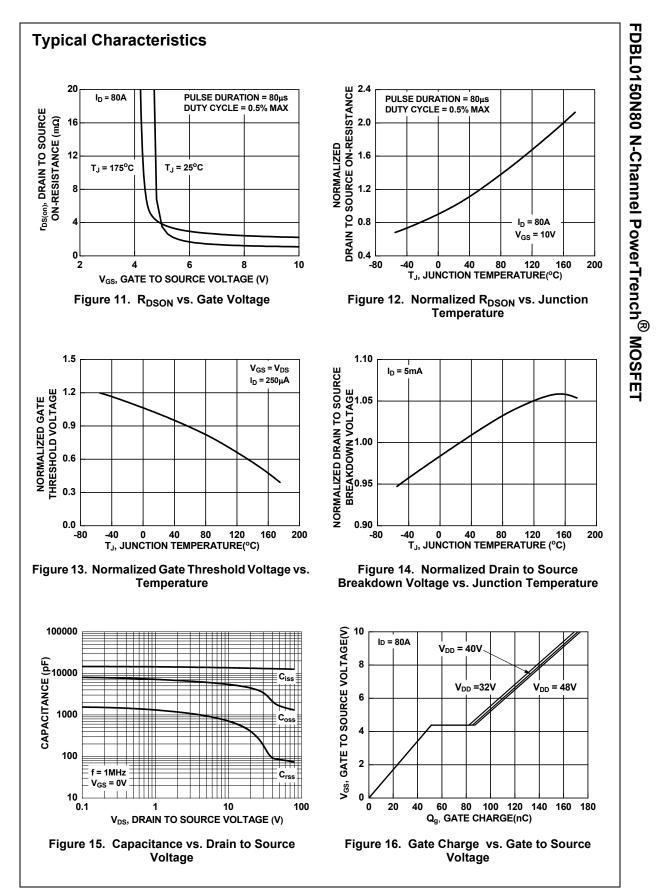
Device Marking	Device	Package			
FDBL0150N80	FDBL0150N80	MO-299A	-	-	-

Symbol	Parameter	Test Conditions		Тур.	Max.	Units
Off Cha	racteristics					
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	80	-	-	V
		$V_{\rm DS}$ =80V, $T_{\rm J}$ =25°C	-	-	1	μA
IDSS	Drain-to-Source Leakage Current	$V_{GS} = 0V$ $T_J = 175^{\circ}C$ (Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	V <sub>GS</sub> = ±20V	-	-	±100	nA
On Cha	racteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA	2.0	3.0	4.0	V
		$I_D = 80A, T_J = 25^{\circ}C$	-	1.1	1.4	mΩ
R <sub>DS(on)</sub>	Drain to Source On Resistance	$V_{GS}$ = 10V $T_{J}$ = 175°C (Note 4)	-	2.4	3.1	mΩ
<b>Dynami</b> C <sub>iss</sub>	c Characteristics			12800	-	pF
C	Output Capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V,		1925	_	pF
C <sub>oss</sub>	Reverse Transfer Capacitance	f = 1MHz f = 1MHz		1323	-	pF
C <sub>rss</sub> P	Gate Resistance			3.0	4.6	ρι Ω
R <sub>g</sub>	Total Gate Charge at 10V			172	188	nC
Q <sub>g(ToT)</sub> Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DD} = 64V$ $V_{GS} = 0 \text{ to } 2V$ $I_D = 80A$		23	27	nC
• • • •	Gate-to-Source Gate Charge	VGS 01021 ID - 00A		51	-	nC
Q <sub>gs</sub> Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			34	-	nC
Switchi	ng Characteristics			1		
t <sub>on</sub>	Turn-On Time		-	-	128	ns
t <sub>d(on)</sub>	Turn-On Delay		-	42	-	ns
t <sub>r</sub>	Rise Time	$V_{DD} = 40V, I_D = 80A,$	-	73	-	ns
t <sub>d(off)</sub>	Turn-Off Delay	V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω	-	87	-	ns
t <sub>f</sub>	Fall Time		-	48	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	193	ns
Drain-S	ource Diode Characteristics					
V <sub>SD</sub>	Source-to-Drain Diode Voltage	I <sub>SD</sub> =80A, V <sub>GS</sub> = 0V	-	-	1.25	V
		$I_{SD}$ = 40A, $V_{GS}$ = 0V	-	-	1.2	V
t <sub>rr</sub>	Reverse-Recovery Time	$I_{F} = 80A, dI_{SD}/dt = 100A/\mu s,$	-	117	136	ns
Q <sub>rr</sub>	Reverse-Recovery Charge	V <sub>DD</sub> =64V		205	269	nC

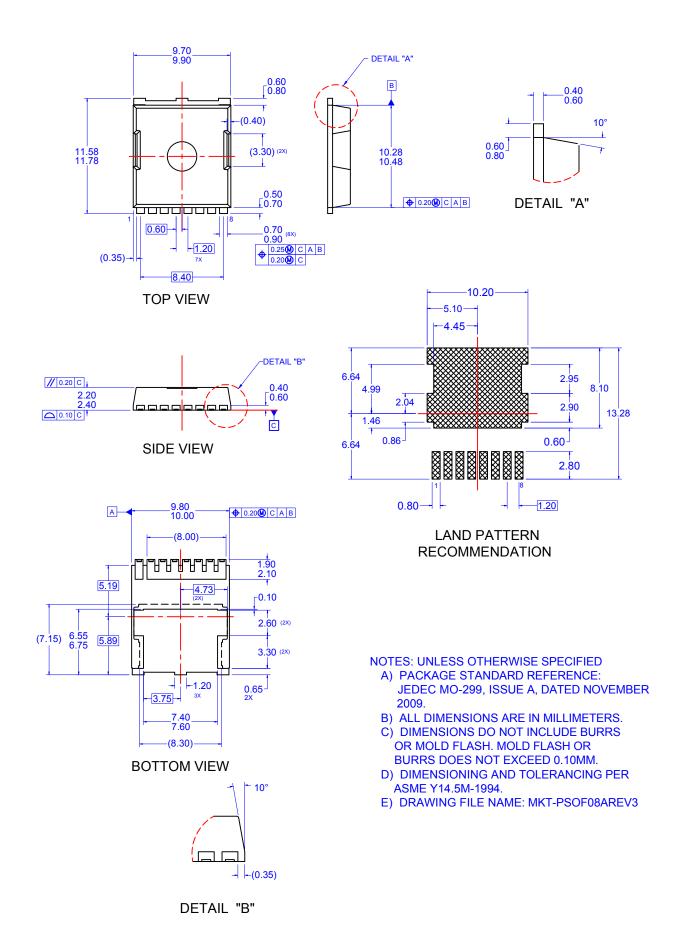




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